SCOPE:

This specification applies to the Pb Free high current type SMD Common mode filter

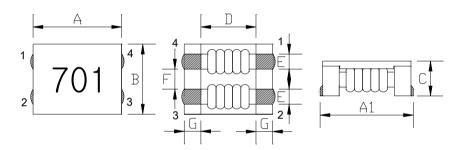
for MCM-1211FH0-SERIES-□□

PRODUCT INDENTIFICATION

MCM-1211F H0- 701 - □□

- (1)
- 2
- 3 4
- **1** Product Code
- **2 Dimensions Code**
- 3 AEC-Q200 Code
- **4** Impedance Code
- **⑤ Inner Control Code**

(1) SHAPES AND DIMENSIONS



A: 12.0±0.5 mm

A1: 12.5±0.5 mm

B: 10.8±0.5 mm

C: 6.5 Max. mm

D: 7.0 Typ. mm

E: 2.7±0.2 mm

F: 2.5±0.2 mm

G: 2.5±0.2 mm

(2) ELECTRICAL SPECIFICATIONS SEE TABLE 1

TEST INSTRUMENTS

Z : HP 4291B OR 4285 IMPEDANCE ANALYZER (or equivalent)

RDC: CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

I.R: CHROMA MODEL 19073 AC/DC/IR HIPOT TESTER (or equivalent)

(3) CHARACTERISTICS

(Including self temp. rise)

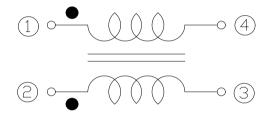
TABLE 1

MAGLAYERS PT/NO.	Impedance(Ω)		Test Frequency	Resistance RDC(Ω) Max.(1 line)	Rated Current	Insulation Resistance	Rated Voltage
	Min.	Тур.	. requerie,		(A) Max.	(MΩ) Min. (V)Max.	(V)Max.
MCM-1211FH0-800-□□	80	230	100MHz/0.5V	2.0m	10.0	10	80
MCM-1211FH0-701-□□	500	700	100MHz/0.5V	6.0m	8.0	10	80
MCM-1211FH0-801-□□	600	800	100MHz/0.5V	8.0m	8.0	10	80
MCM-1211FH0-102-□□	750	1000	100MHz/0.5V	14 m	6.0	10	80
MCM-1211FH0-222-□□	2200	2500	10MHz/0.5V	35 m	1.8	10	80
MCM-1211FH0-272-	2300	2700	10MHz/0.5V	50 m	1.5	10	80

Rated Current: Based on temperature rise ($\triangle T:40^{\circ}C$ TYP.)

CHARACTERISTICS(REFERENCE)

CIRCUIT DIAGRAM



(4) RELIABILITY TEST METHOD

MECHANICAL

TEST ITEM	SPECIFICATION	TEST DETAILS		
Solder ability	The product shall be connected to the test	Apply cream solder to the printed circuit board .		
	circuit board by the fillet (the height is 0.2mm).	Refer to clause 8 for Reflow profile.		
Resistance to	There shall be no damage or problems.	Temperature profile of reflow soldering		
Soldering heat		© 300 — soldering (Peak temperature 260±3°C 10 sec)		
(reflow soldering)		Soldering (Peak temperature 260±3°C 10 sec) Pre-heating Pre-heating Slow cooling (Stored at room temperature)		
		200 – 30 sec Min		
		Fre-heating / (230+°°C)		
		Slow cooling (Stored at room		
		temperature)		
		10		
		2 min sec 2 min. or more		
		The specimen shall be passed through the reflow oven		
		with the condition shown in the above profile for 1 time.		
		The specimen shall be stored at standard atmospheric		
		eric conditions for 1 hour, after which the measurement shall be made.		
		Shall be made.		
Terminal strength	The terminal electrode and the ferrite must	Solder a chip to test substrate , and then laterally apply		
	not damaged.	a load 9.8N in the arrow direction.		
		Printed circuit board \$\phi_{1.0}\$		
Strength on PC board	The terminal electrode and the ferrite must	Solder a chip to test substrate and then apply a load.		
bending	not damaged.	Test board:FR4 100×40×1mm R10 Fall speed:1mm/sec. Dimensions in mm		
High	Impedance:Within±20% of the initial value.	After the samples shall be soldered onto the test circuit		
temperature	Insulation resistance and DC resistance on the	board,the test shall be done.		
resistance	specification(refer to clause 2-1) shall be met.	Measurement : After placing for 24 hours min.		
	The terminal electrode and the ferrite must not	Temperature: +155±2℃		
	damaged.	Applied voltage : Rated voltage		
		Applied current : Rated current		
		Testing time : 500±12 hours		
MSL	No apparent damage	85℃ 、85%RH FOR 1000 HOURS		
	Fulfill the electrical spec. after test.			
	and the contract open and took			

(4) RELIABILITY TEST METHOD

MECHANICAL

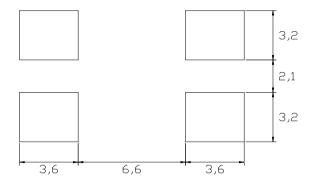
TEST ITEM	SPECIFICATION	TEST DETAILS		
Humidity	Impedance:Within±20% of the initial value.	After the samples shall be soldered onto the test circuit		
resistance	Insulation resistance and DC resistance on the	board,the test shall be done.		
	specification(refer to clause 2-1) shall be met.	Measurement : After placing for 24 hours min.		
	The terminal electrode and the ferrite must not	Temperature : +60±2℃ , Humidity : 90 to 95 %RH		
	damaged.	Applied voltage : Rated voltage		
		Applied current : Rated current		
		Testing time : 500±12 hours		
Thermal shock	Impedance:Within±20% of the initial value.	1 cycle		
	Insulation resistance and DC resistance on the	1 cycle		
	specification(refer to clause 2-1) shall be met.	+155°C 30 sec		
	The terminal electrode and the ferrite must	\ '/ \		
	not damaged.	-40°C \		
		30 min.		
Low	Impedance:Within±20% of the initial value.	After the samples shall be soldered onto the test		
temperature	Insulation resistance and DC resistance on the	circuit board,the test shall be done.		
storage	specification(refer to clause 2-1) shall be met.	Measurement : After placing for 24 hours min.		
_	The terminal electrode and the ferrite must	Temperature : -40±2℃		
	not damaged.	Testing time : 500±12 hours		
Vibration	Impedance:Within±20% of the initial value.	After the samples shall be soldered onto the test circuit		
	Insulation resistance and DC resistance on	board,the test shall be done.		
	the specification(refer to clause 2-1)	Frequency : 10 to 55 Hz		
	shall be met.	Amplitude : 1.52 mm		
	The terminal electrode and the ferrite must	Dimension and times : X ,Y and Z directions		
	not damaged.	for 2 hours each.		
Solderability	New solder More than 75%	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated		
		over the whole of the sample before hard, the sample shall		
		then be preheated for about 2 minutes in a temperature		
		of 130~150℃ and after it has been immersed to a depth		
		0.5mm below for 3±0.2 seconds fully in molten solder		
		M705 with a temperature of 245±5°C. More than 75% of the		
		electrode sections shall be couered		
		with new solder smoothly when the sample is taken out		
		of the solder bath.		
High Town with				
High Temp with	After relibility test △L within ±20%	1000hrs.at rated operating temperature (e.g. 155°C part can be stored for 1000hrs.@ 155°C.Same applies for 125°C and 105°C. Unpowered. Measurement at 24±4 hours after test conclusion.		

(5) LAND DIMENSION (Ref.)

PCB: GLASS EPOXY t=1.6mm

(5)-1 LAND PATTERN DIMENSIONS

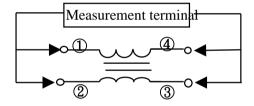
(STANDARD PATTERN) Unit: mm



(6) TEST EQUIPMENT

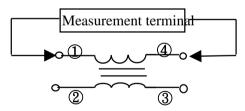
(6)-1 Impedance

Measured by using HP4291B RF Impedance Analyzer.



(6)-2 DC Resistance

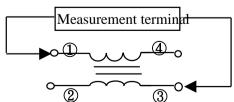
Measured by using Chroma 16502 milliohm meter.



(6)-3 Insulation Resistance

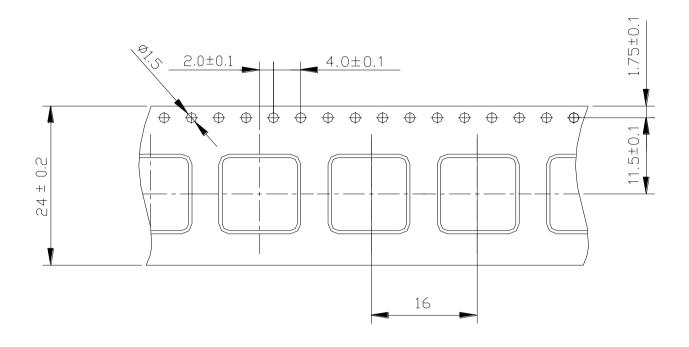
Measured by using Chroma 19073

Measurement voltage: 50v, Measurement time: 60 sec.



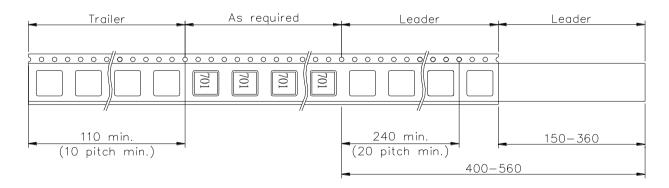
(6) PACKAGING

(6)-1 CARRIER TAPE DIMENSIONS (mm)

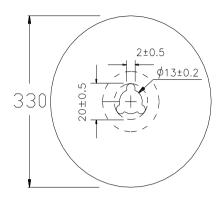


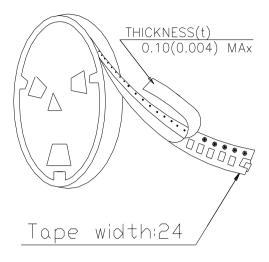
(6)-2 TAPING DIMENSIONS (mm)





(6)-3 REEL DIMENSIONS (mm)





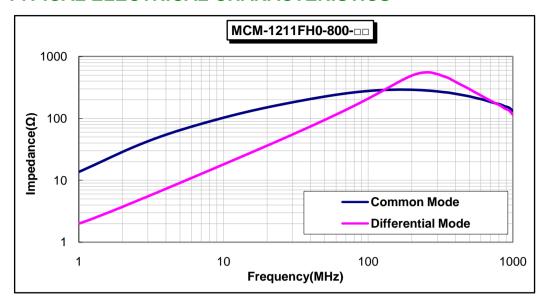
(6)-4 QUANTITY

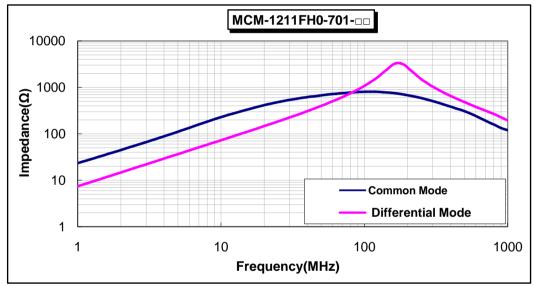
500 pcs/Reel

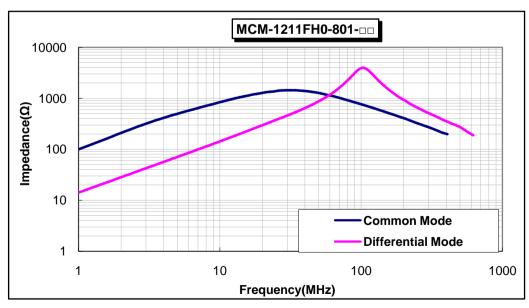
The products are packaged so that no damage will be sustained.

Please note that the contents may change without any prior notice due to reasons such as upgrading.

TYPICAL ELECTRICAL CHARACTERISTICS









TYPICAL ELECTRICAL CHARACTERISTICS

